

MN15G1601

Type		MN15G1601	
ROM (×8-bit)		16 K	
RAM (×4-bit)		512	
Package		LQFP064-P-1414 *Lead-free	
Number of Instructions		103	
Minimum Instruction Execution Time		0.5 μs at 1/4 frequency dividing (at 3.0 V to 5.5 V, 8 MHz)	
		1.0 μs at 1/4 frequency dividing (at 2.4 V to 5.5 V, 4 MHz)	
		2.0 μs at 1/8 frequency dividing (at 2.0 V to 5.5 V, 4 MHz)*	
		* The lower limit for operation guarantee for EPROM built-in type is 2.3 V.	
Interrupts		• RESET • IRQ1 • IRQ2 • IRQ3	
Timer Counter		Timer counter 0 : 8-bit × 1 (event count, pulse output, simple pulse width meausurement, PWM output, remote control carrier output) Clock source 1/2, 1/8, 1/32, 1/128 of system clock frequency; 1/1, 1/4, 1/16, 1/64 of XI(OSC) oscillation clock frequency	
		Timer counter 1 : 8-bit × 1 (event count, pulse output, remote control carrier output) Clock source 1/2 of system clock frequency; 1/1, 1/2 ¹⁴ of OSC oscillation clock frequency; 1/1, 1/2 ⁶ of XI oscillation clock frequency Possible 16-bit cascade connection with timer counter 0	
		Timer counter 2 : 8-bit × 1 (event count, pulse output, simple pulse width meausurement, PWM output, remote control carrier output, one-shot timer output, trigger start PWM output, trigger start timer output) Clock source 1/2 of system clock frequency; 1/1, 1/2 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; TCI input	
		Timer counter 3 : 8-bit × 1 (event count, pulse output, remote control carrier output, high-functional PWM output) Clock source 1/2 of system clock frequency; 1/1, 1/2 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; TCI input Possible 16-bit cascade connection with timer counter 2	
		Watchdog timer	
Serial Interface		Serial : 8-bit × 1 (synchronous type) Clock source 1/1, 1/2 of system clock frequency; SBT pin input	
I/O Pins	I/O	35	• Common use : 31 • Specified pull-up resistor available : 27 (software programmable) • Specified output architecture available : Nch open drain / push-pull : 31 (software programmable)
A/D Inputs		10-bit × 8-ch. (with S/H)	
LCD		30 segments × 4 commons (1/2 , 1/3 , 1/4 duty)	
Zero-Cross Inputs		1	
Special Ports		Buzzer output (1 kHz, 2 kHz, 4 kHz : fosc = at 4 MHz)	

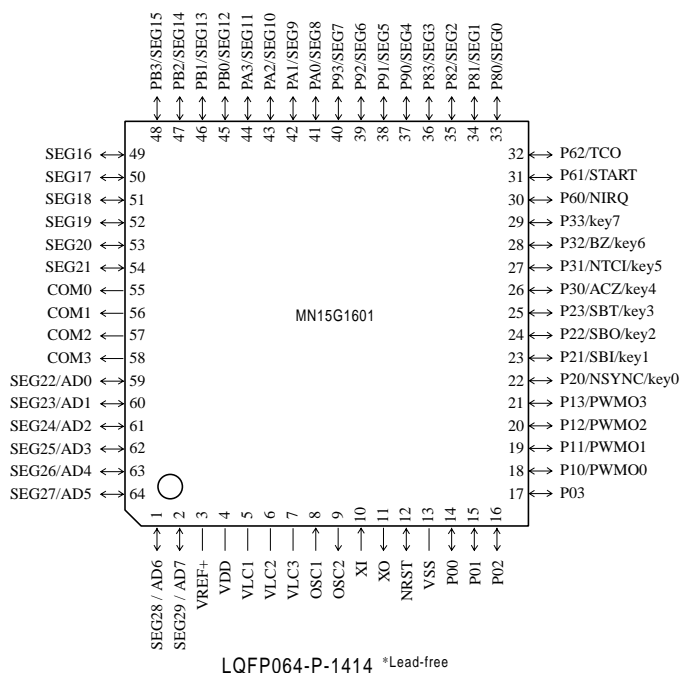
Electrical Characteristics

Supply current

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Operating supply current	IDD1	fosc = 8 MHz (1/8 dividing)		1.8	3.5	mA
	IDD2	fosc = 4 MHz (1/8 dividing)		1.2	2.5	mA
	IDD3	fosc = 32.768 kHz (1/8 dividing)		9.0	20	μA
Supply current at HALT	IDD4	fosc = 4 MHz (1/8 dividing)		0.3	0.6	mA
	IDD5	fosc = 32.768 kHz (1/8 dividing)		1.5	8.0	μA
Supply current at STOP	IDD6	ACZ = 1/2 VDD, Ta = 25°C		4.0	10	μA
	IDD7	ACZ = 1/2 VDD, Ta = -40°C to +85°C			30	μA
	IDD8	Ta = 25°C			1.0	μA
	IDD9	Ta = -40°C to +85°C			5.0	μA

(Ta = -40°C to +85°C, VDD = 5.0 V, VSS = 0 V)

Pin Assignment



SupportTool

In-circuit Emulator	PX-ICE1500 + PX-PRB15G1601-LQFP064-P-1414	
EPROM Built-in Type	Type	MN15GP1601
	ROM (× 8-bit)	16 K
	RAM (× 4-bit)	512
	Minimum instruction execution time	0.5 μs at 1/4 frequency dividing (at 3.0 V to 5.5 V, 8 MHz) 1.0 μs at 1/4 frequency dividing (at 2.4 V to 5.5 V, 4 MHz) 2.0 μs at 1/8 frequency dividing (at 2.3 V to 5.5 V, 4 MHz)
	Package	LQFP064-P-1414 *Lead-free

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